IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

Docket No. 26787-CNT1

KOPER, OLGA et al.

Group Art Unit No. 1754

Serial No.:

Filed:

REACTIVE NANOPARTICLES AS DESTRUCTIVE ADSORBENTS FOR BIOLOGICAL AND CHEMICAL CONTAMINATION

Examiner:

Commissioner for Patents Alexandria, VA 22313-1450

Sir:

INFORMATION DISCLOSURE STATEMENT

The attached references are being filed to fulfill the duty of candor and good faith toward the

Patent and Trademark Office, as required by 37 C.F.R. §1.56.

Respectfully submitted,

HOVEY WILLIAMS LLP

Greg Skoch, Reg. No. 48,267

2405 Grand Boulevard, Suite 400

Kansas City, Missouri 64108

(816) 474-9050

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		FILING DATE:	GROUP:	

U.S. PATENT DOCUMENTS

EXAM. INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	3,915,350	Oct. 28, 1975	Davies et al.			
	4,770,715	Sep.13, 1988	Mandel et al.			
	5,262,150	Nov. 16, 1993	Laugier et al.			
	5,499,587	Mar. 19, 1996	Rodriguez et al.			
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	6,183,785	Feb. 6, 2001	Westfall		-	
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FOREIGN PATENT DOCUMENTS

DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
JP 08-325467	Dec. 10,1996	Japan			YES	NO
						

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.